

Electronics production in Europe

Ensure competitiveness with intelligent inspection concepts and innovative product ideas

In the medium term, only those electronics producers that meet the highest quality requirements and optimize their production processes will stay in business. To avoid defects, the causes must be identified and systematically eliminated. Linking various inspection gates creates wide-ranging possibilities for cost optimization and process reliability and permanent improvements in product quality. Constant development of inspection technology is essential.

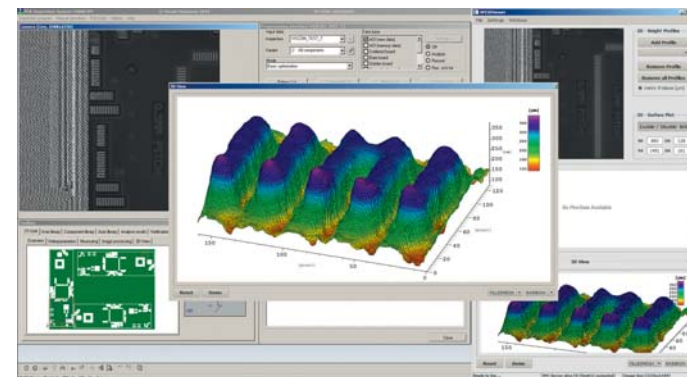


The inspection systems from Viscom are intelligently linked in the production line

Without doubt, the electronic design of a product must primarily meet customers' expectations. But developers should also take into account costs for material, production and inspectability and adapt their concept to these requirements. In this way, later production errors and unnecessary costs can be avoided. E-CAD designers in a company with its own production can take advantage of the short communication paths and discuss necessary production processes with the in-house experts. Companies that rely on the support of an EMS service provider (electronics manufacturing services) for manufacturing should contact the specialists working there. Performance of failure mode effects analyses, abbreviated FMEAs, is recommended. With aids such as the Ishikawa diagram, developers and experts can together determine what influence the 5-Ms (manpower, machines, methods, material, measurement) and

the related risks have for the origination process of the product. The goal is to produce innovative products with no defects in an optimized production process.

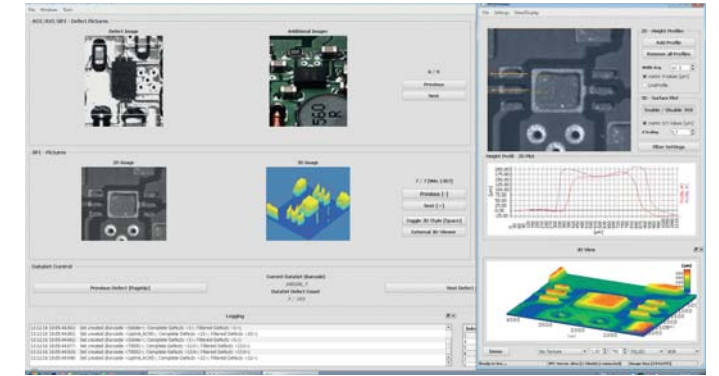
Data from experience are important for evaluating risks correctly. In electronics production, automatic inspection systems provide such experience continuously in the form of both data and images. Results from solder paste inspection provide information about the quality of the solder paste print designs and of the printing process. The print template used is created based on Gerber data generated from the E-CAD system. If the specifications defined in it are not optimally adapted to the production conditions, there will be systematic solder problems. The aperture geometries of solder paste surfaces in the E-CAD system should be coordinated regularly between the developer and the production expert responsible for the solder paste print. The SPI system (solder paste inspection) provides the data required for efficient coordination.



Depiction of a bridge with 3D SPI



The 3D AOI system S3088 ultra gold from Viscom convinces users with its ultra-modern high performance camera technology and highest throughput



The results of the various inspection gates can be merged with clarity

The Viscom solder paste inspection system, for example, has interfaces with both the paste printer and the assembler. In accordance with Industry 4.0, the result data from the downstream SPI system is read by the printer and correction measures are automatically introduced, such as template cleaning or correction of a template offset. With increasing miniaturization, transmission of the SPI result logs to the assembly machines is becoming more and more important, as assembly of very small components (01005, 03015) and of components with small pitch (< 500 µm) to the actual position of the solder paste has been shown to result in fewer defects than assembly of the components to the target position relative to the register mark in the copper.

In addition, the results of the solder paste and assembly inspection before the oven can be clearly merged with those of the post-reflow solder joint inspection with AOI and X-ray. The data and images gained can be used by both the process owners and the product developers to identify and systematically eliminate causes of defects in the process and design. Special software tools, such as the Viscom Quality Uplink with Viscom Uplink Process Analyzer (VUPA) or the Viscom SPC software (statistical process control) help with evaluation and visualization of the many results collected by Viscom inspection systems. The advantages include a reliable separation of classes between genuine defects and false calls (false reports). Many possibilities are thus available to take process-relevant information into account early and thus optimize the production process. This is especially successful when reaction times can be kept as short as possible. To achieve this, Viscom offers the possibility to have all process-relevant data available on smartphones and tablets.

About the presentation

Electronics designers rely on data from experience for their development work. Automatic inspection systems not only reliably detect defects, but also provide important quality data and microscopic images of defective layouts. This is an important contribution to future avoidance of design-related defect causes. In the production process, in turn, costs are optimized, process reliability is increased, and product quality is improved through linking of the data of different inspection gates.

Benefit statement

Electronics manufacturers must constantly optimize their production processes using the latest inspection technology. Development of an attractive, easy to produce, but still robust product today requires close interaction between all who participate in the origination process. Intelligent inspection significantly helps to optimize solutions, processes and costs, from development to production.



Profile

The Viscom AG is one of the world's leading providers of automatic inspection systems for electronic assemblies. The model range reaches from high-performance 3D AOI systems for inspecting solder paste, placement and solder joints, to inspection systems for MID, wire bond and conformal coating inspections. The X-ray inspection area covers the complete bandwidth from microfocus X-ray tubes through offline inspection islands with µCT function, up to fully automated 3D in-line X-ray inspection. Viscom systems are technologically cutting-edge products and have been successfully applied around the world by well-known companies in the most widely varying branches – reaching from the automotive and electronics industries through aerospace technology, and up to the medical technology and semiconductor industries. With branch offices in Europe, Asia and the USA, as well as a tight network of representatives, Viscom is present around the globe.

www.viscom.com



Speaker: Hagen Berger, New Business Development Manager Viscom AG

Hagen Berger has been working for more than 10 years in the field of optical measurement and inspection. After he finished his studies in mechanical engineering he was working in Philadelphia, USA. He gained experiences as product manager and is now focusing on innovative concepts and ideas around Industry 4.0, digitization, big data and Internet of things.



Mobile real-time access to production and quality with the Viscom app